

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|--|---|------------------|---------|------------------|
| L1 | 0 | (integrated adj chip and substrate and thickness and (ground\$3 adj plane)).clm. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/01/22 22:09 |
| L2 | 0 | (integrated adj chip and substrate and thick\$4 and (ground\$3 adj plane)).clm. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/01/22 22:09 |